Power MOSFET -60V, 250mΩ, -1.8A, P-Channel

Automotive Power MOSFET designed to minimize gate charge and low on resistance. AEC-Q101 qualified MOSFET and PPAP capable suitable for automotive applications.

Features

- 4V drive
- High ESD protection
- Low On-Resistance
- AEC-Q101 qualified and PPAP capable
- Pb-Free, Halogen Free and RoHS compliance

Typical Applications

- Reverse Battery Protection
- High Side Load Switch
- Automotive Body Controllers

SPECIFICATIONS

Parameter	Symbol	Value	Unit
Drain to Source Voltage	VDSS	-60	V
Gate to Source Voltage	VGSS	±20	V
Drain Current (DC) (Note 2)	ID	-1.8	А
Drain Current (DC) (Note 3)	טי	-1.7	А
Drain Current (Pulse) PW $\leq 10\mu$ s, duty cycle $\leq 1\%$	IDP	-7.2	А
Power Dissipation Ta=25°C(Note 2)	•		W
Power Dissipation Ta=25°C(Note 3)	טין	0.8	W
Junction Temperature and Storage Temperature	Tj, Tstg	-55 to +175	°C

Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Value	Unit
Junction to Ambient	(Note 2)	Pola	125	°C/W
	(Note 3)	R _θ JA	182	°C/W

Note 2 : Surface mounted on ceramic substrate(900mm $^2 \times$ 0.8mm).

Note 3 : Surface mounted on FR4 board using a 92mm², 1 oz. Cu pad.

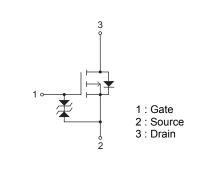


ON Semiconductor®

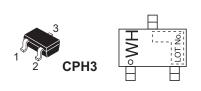
www.onsemi.com

VDSS	R _{DS} (on) Max	ID Max
	250mΩ@ –10V	
-60V	330mΩ@ –4.5V	-1.8A
	350mΩ@ –4.0V	

ELECTRICAL CONNECTION P-Channel







ORDERING INFORMATION

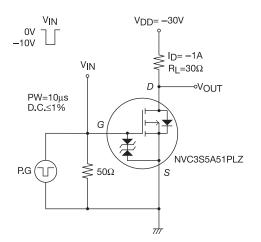
See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS at $Ta = 25^{\circ}C$ (Note 4)

Parameter	O make at	Conditions		Value		
Parameter	Symbol	bol Conditions		typ	max	Unit
Drain to Source Breakdown Voltage	V(BR)DSS	I _D =-1mA, V _{GS} =0V	-60			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =-60V, V _{GS} =0V			-1	μA
Gate to Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μA
Gate Threshold Voltage	VGS(th)	V _{DS} =-10V, I _D =-1mA	-1.2		-2.6	V
Forward Transconductance	9FS	V _{DS} =-10V, I _D =-1A		2.7		S
		I _D =-1A, V _{GS} =-10V		190	250	mΩ
Static Drain to Source On-State Resistance	R _{DS} (on)	ID=-0.5A, VGS=-4.5V		235	330	mΩ
Resistance		ID=-0.5A, VGS=-4V		250	350	mΩ
Input Capacitance	Ciss			262		pF
Output Capacitance	Coss	V _{DS} =–20V, f=1MHz		29		pF
Reverse Transfer Capacitance	Crss			19		pF
Turn-ON Delay Time	t _d (on)			5.1		ns
Rise Time	tr			5.4		ns
Turn-OFF Delay Time	t _d (off)	See Fig.1		34		ns
Fall Time	tf			19		ns
Total Gate Charge	Qg			6.0		nC
Gate to Source Charge	Qgs	V _{DS} =-30V, V _{GS} =-10V, I _D =-1.8A		0.83		nC
Gate to Drain "Miller" Charge	Qgd]		1.3		nC
Forward Diode Voltage	V _{SD}	IS=-1.8A, VGS=0V		-0.82	-1.2	V

Note 4 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Fig.1 Switching Time Test Circuit



-3.0

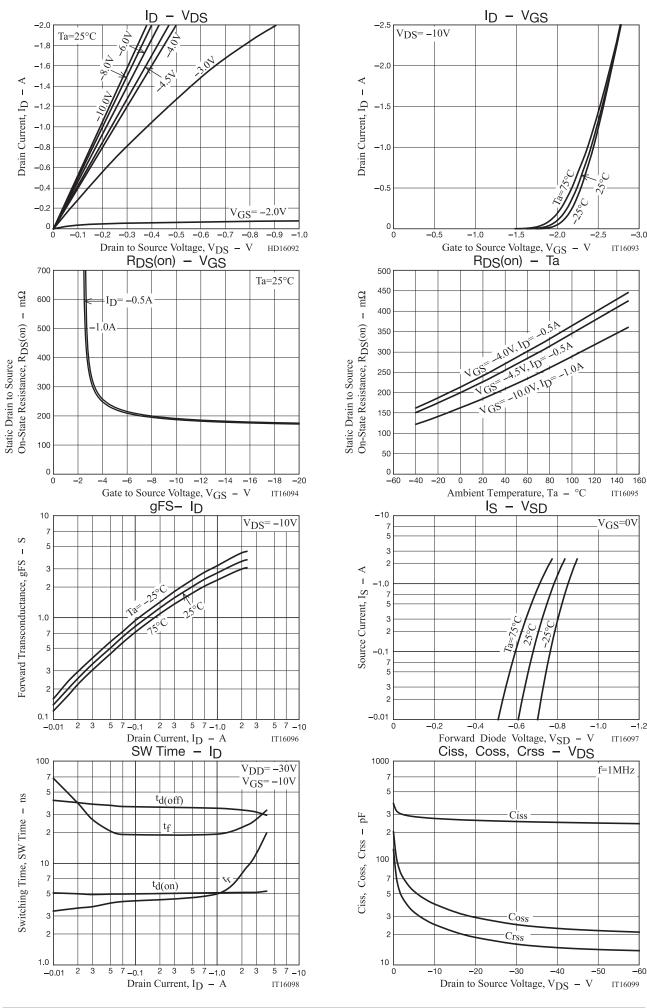
IT16093

IT16095

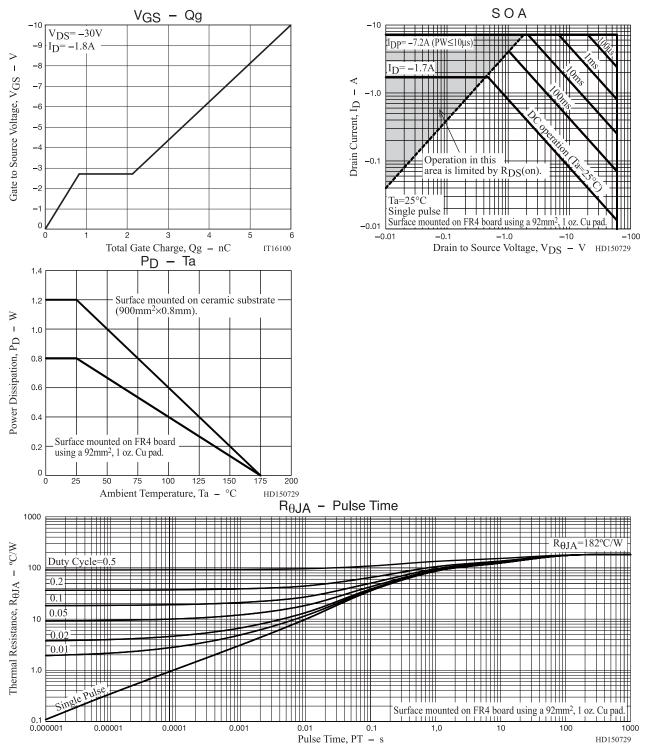
-1.2

-60

IT16097



www.onsemi.com 3

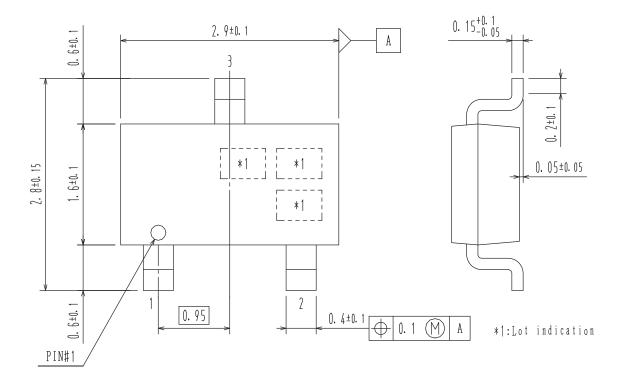


PACKAGE DIMENSIONS

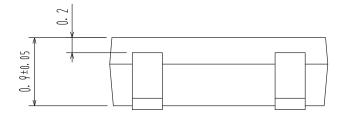
unit : mm

CPH3

CASE 318BA ISSUE O



RECOMMENDED SOLDERING FOOTPRINT



- 1 : Gate
- 2 : Source
- 3 : Drain

5-

0.95 0.95

ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)		
NVC3S5A51PLZT1G	WH	CPH3 (Pb-Free / Halogen Free)	3,000 / Tape & Reel		

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage : Since the NVC3S5A51PLZ is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

ON Semiconductor and the ON logo are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC wase negligent regarding the design or manufact